

LNPTM THERMOCOMPTM COMPOUND D551

DESCRIPTION

LNP THERMOCOMP D551 compound is based on Polycarbonate (PC) resin containing 50% glass fiber. Added features of this grade include: High Modulus, Low Warpage, Good Ductility, Non-Brominated & Non-Chlorinated Flame Retardant.

GENERAL INFORMATION	
Features	Flame Retardant, Low Warpage, Non Cl/Br flame retardant, High stiffness/Strength, Impact resistant
Fillers	Glass Fiber
Brands	LNPTM THERMOCOMPTM
Polymer Types	Polycarbonate (PC)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Building and Construction	Building Component
Consumer	Personal Accessory
Electrical and Electronics	Mobile Phone - Computer - Tablets
Industrial	Electrical

TYPICAL PROPERTY VALUES

TEST METHODS PROPERTIES **TYPICAL VALUES** UNITS MECHANICAL⁽¹⁾ Tensile Stress, brk, Type I, 5 mm/min 154 MPa ASTM D638 2.1 Tensile Strain, brk, Type I, 5 mm/min % ASTM D638 15320 MPa ASTM D638 Tensile Modulus, 5 mm/min Flexural Stress, brk, 1.3 mm/min, 50 mm span 223 MPa ASTM D790 ASTM D790 Flexural Modulus, 1.3 mm/min, 50 mm span 13820 MPa Tensile Stress, break, 5 mm/min 153 MPa ISO 527 Tensile Strain, break, 5 mm/min 1.9 % ISO 527 15130 Tensile Modulus, 1 mm/min MPa ISO 527 IMPACT (1) Izod Impact, unnotched, 23°C 520 J/m ASTM D4812 Izod Impact, notched, 23°C 127 J/m ASTM D256 Instrumented Dart Impact Energy @ peak, 23°C 21 ASTM D3763 Charpy 23°C, V-notch Edgew 80*10*4 sp=62mm 12 kJ/m² ISO 179/1eA Charpy 23°C, Unnotch Edgew 80*10*4 sp=62mm 38 kJ/m² ISO 179/1eU THERMAL (1) °C HDT, 1.82 MPa, 3.2mm, unannealed 107 ASTM D648 CTF. -40°C to 40°C, flow 1 39F-05 1/°C ASTM E831 CTE, -40°C to 40°C, xflow 4.15E-05 1/°C ASTM E831 °C Relative Temp Index, Elec (2) 80 UL 746B Relative Temp Index, Mech w/impact $^{\rm (2)}$ °C UL 746B 80

© 2024 Copyright by SABIC. All rights reserved

CHEMISTRY THAT MATTERS

Revision 20241021



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Relative Temp Index, Mech w/o impact ⁽²⁾	80	°C	UL 746B
PHYSICAL ⁽¹⁾			
Density	1.635	g/cm³	ASTM D792
Mold Shrinkage, flow, 24 hrs ⁽³⁾	0.05 – 0.2	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽³⁾	0.05 – 0.2	%	ASTM D955
Melt Volume Rate, MVR at 300°C/2.16 kg	17	cm ³ /10 min	ASTM D1238
Melt Flow Rate, 300°C/5.0 kgf	48.6	g/10 min	ASTM D1238
Melt Volume Rate, MVR at 300°C/5.0 kg	29	cm³/10 min	ASTM D1238
ELECTRICAL ⁽¹⁾			
Volume Resistivity	2.15E+16	Ω.cm	ASTM D257
Surface Resistivity	5.00E+16	Ω	ASTM D257
Dielectric Constant, 1.1 GHz	4.07	-	SABIC method
Dielectric Constant, 1.9 GHz	4.1	-	SABIC method
Dielectric Constant, 5 GHz	4.09	-	SABIC method
Dissipation Factor, 1.1 GHz	0.00762	-	SABIC method
Dissipation Factor, 1.9 GHz	0.00811	-	SABIC method
Dissipation Factor, 5 GHz	0.00896		SABIC method
FLAME CHARACTERISTICS (2)			
UL Yellow Card Link	E207780-101219669	-	
UL Recognized, 94V-0 Flame Class Rating	≥1	mm	UL 94
UL Recognized, 94V-1 Flame Class Rating	≥0.8	mm	UL 94
INJECTION MOLDING ⁽⁴⁾			
Drying Temperature	110	°C	
Drying Time	3 – 6	Hrs	
Drying Time (Cumulative)	12	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	285 – 310	°C	
Nozzle Temperature	285 – 305	°C	
Front - Zone 3 Temperature	280 – 300	°C	
Middle - Zone 2 Temperature	270 – 290	°C	
Rear - Zone 1 Temperature	260 – 280	°C	
Mold Temperature	80 - 110	°C	
Back Pressure	0.1 – 0.3	MPa	
Screw Speed	50 – 90	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.

(3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

MORE INFORMATION

For curve data and CAE cards, please visit and register at https://materialfinder.sabic-specialties.com



DISCLAIMER

Any sale by SABIC, its subsidiaries and affiliates (each a "seller"), is made exclusively under seller's standard conditions of sale (available upon request) unless agreed otherwise in writing and signed on behalf of the seller. While the information contained herein is given in good faith, SELLER MAKES NO WARRANTY, EXPRESS OR IMPLIED, INCLUDING MERCHANTABILITY AND NONINFRINGEMENT OF INTELLECTUAL PROPERTY, NOR ASSUMES ANY LIABILITY, DIRECT OR INDIRECT, WITH RESPECT TO THE PERFORMANCE, SUITABILITY OR FITNESS FOR INTENDED USE OR PURPOSE OF THESE PRODUCTS IN ANY APPLICATION. Each customer must determine the suitability of seller materials for the customer's particular use through appropriate testing and analysis. No statement by seller concerning a possible use of any product, service or design is intended, or should be construed, to grant any license under any patent or other intellectual property right.